

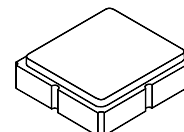
**MAXIMUM RATING:**

Input Power Level: 10 dBm

- DC Voltage : 3V
- Operating Temperature: -30°C to +85°C
- Storage Temperature: -40°C to +85°C
- Implementation of IIP3: 30dBm min.
- Moisture Sensitivity Level: 1
- AEC-Q200 Qualified

**SF2625E**

**500 MHz  
SAW Filter**



SM3030-8

Automotive grade product

**ELECTRICAL CHARACTERISTICS:**

Ambient Temperature: 25 °C

Item	Unit	Min.	Typ.	Max.	
<b>Center frequency</b> Fc	MHz	-	500	-	
<b>Max. Insertion loss (Fc ± 75 kHz) (Including loss in matching elements)</b> IL	dB	-	4.0	7.5	
<b>Passband Ripple (Fc ± 75 kHz)</b>	dB	-	0.4	2.0	
<b>Group Delay Ripple (Fc ± 75 kHz)</b>	µsec	-	0.45	2.0	
<b>Relative Attenuation (relative to IL)</b>					
<b>Fc - 100 to Fc - 1.5</b>	MHz	dB	35	52	-
<b>Fc - 1.5 to Fc - 0.8</b>	MHz	dB	20	44	-
<b>Fc - 0.8 to Fc - 0.6</b>	MHz	dB	10	40	-
<b>Fc - 0.6 to Fc - 0.4</b>	MHz	dB	7	24	-
<b>Fc + 0.4 to Fc + 0.6</b>	MHz	dB	7	22	-
<b>Fc + 0.6 to Fc + 0.8</b>	MHz	dB	10	35	-
<b>Fc + 0.8 to Fc + 1.5</b>	MHz	dB	20	43	-
<b>Fc + 1.5 to Fc + 100</b>	MHz	dB	35	52	-
<b>Temperature coefficient of frequency</b> TCF		-0.036 ppm/°C <sup>2</sup>			

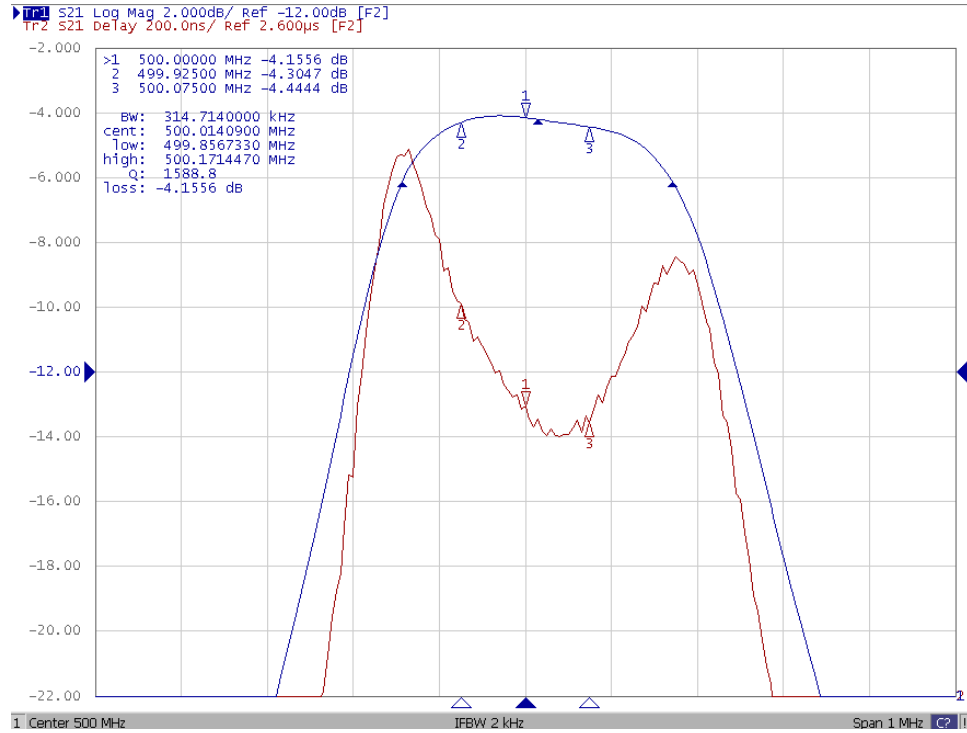
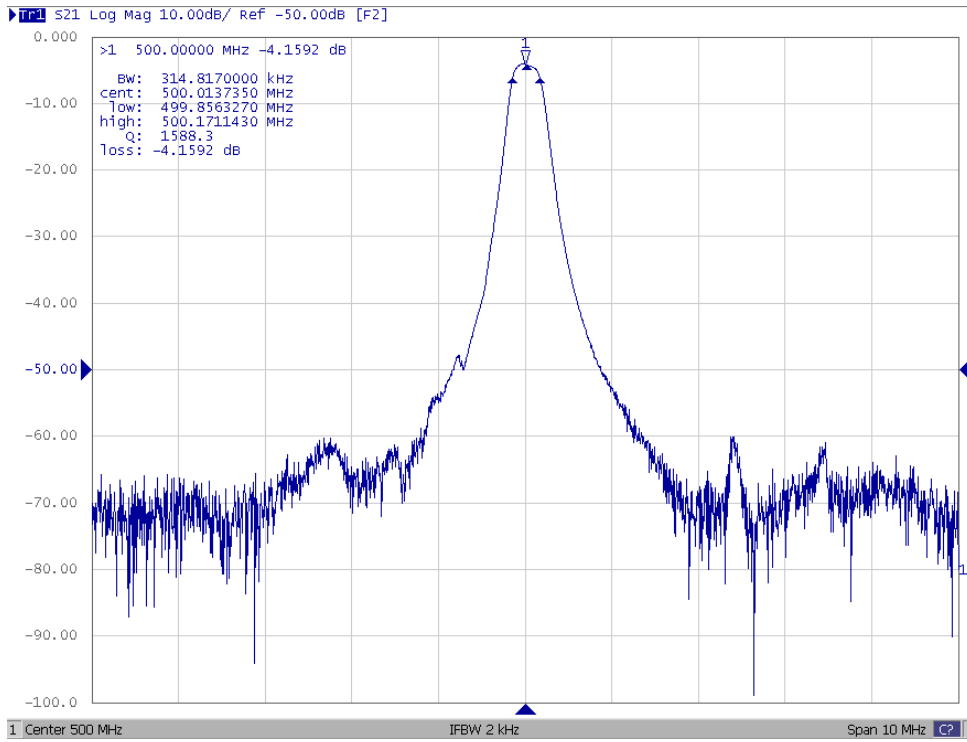


**CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.**

**NOTES:**

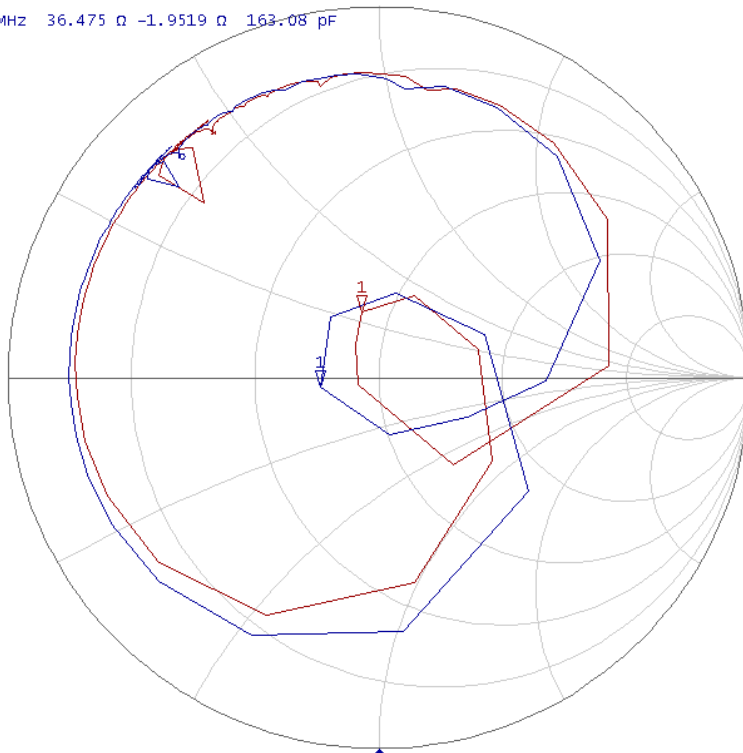
1. The design, manufacturing process, and specifications of this device are subject to change.
2. US or International patents may apply.
3. RoHS compliant from the first date of manufacture.

# FREQUENCY CHARACTERISTICS:



Tr1 S11 Smith (R+jX) Scale 1.000U [F2]  
Tr2 S22 Smith (R+jX) Scale 1.000U [F2]

>1 500.00000 MHz 36.475  $\Omega$  -1.9519  $\Omega$  163.08 pF



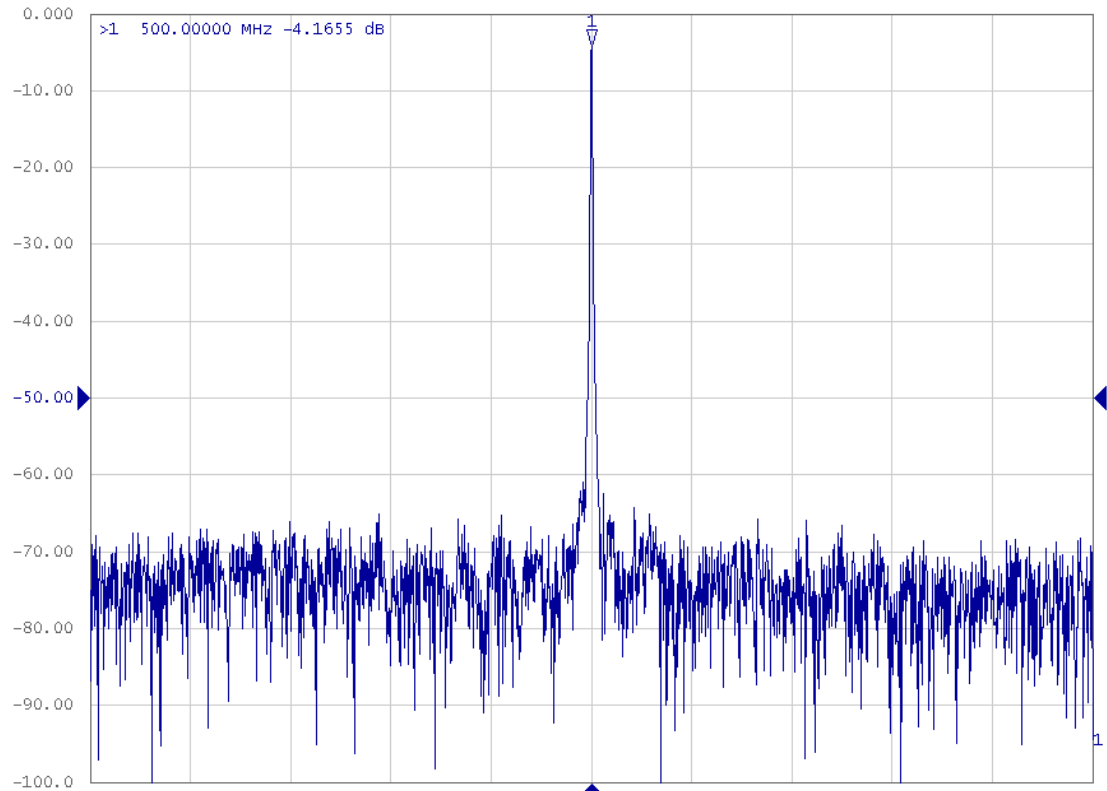
Center 500 MHz

IFBW 2 kHz

Span 10 MHz

Tr1 S21 Log Mag 10.00dB/ Ref -50.00dB [F2]

>1 500.00000 MHz -4.1655 dB



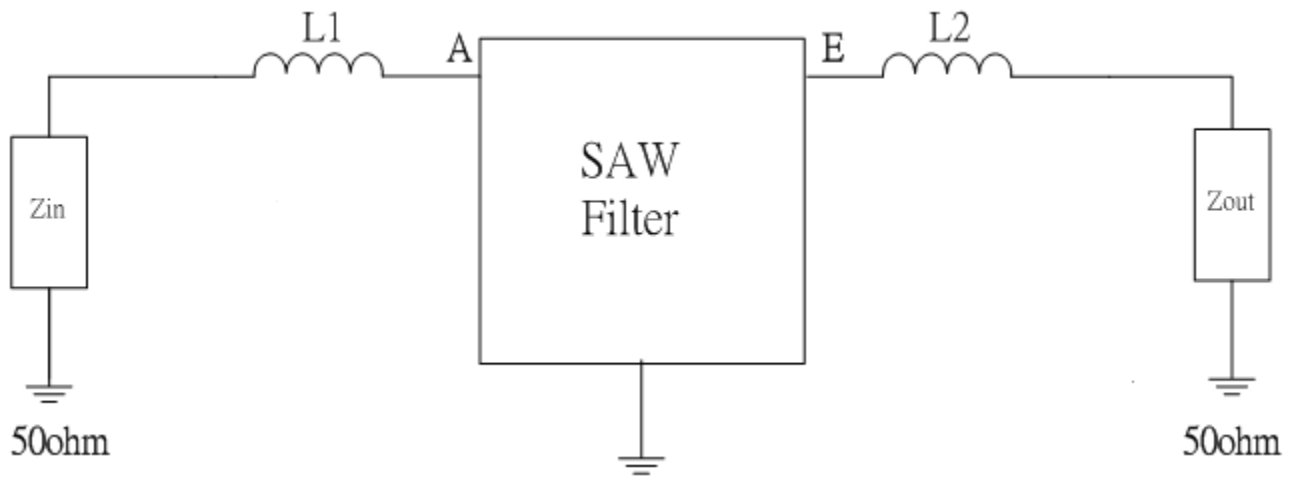
Center 500 MHz

IFBW 2 kHz

Span 200 MHz

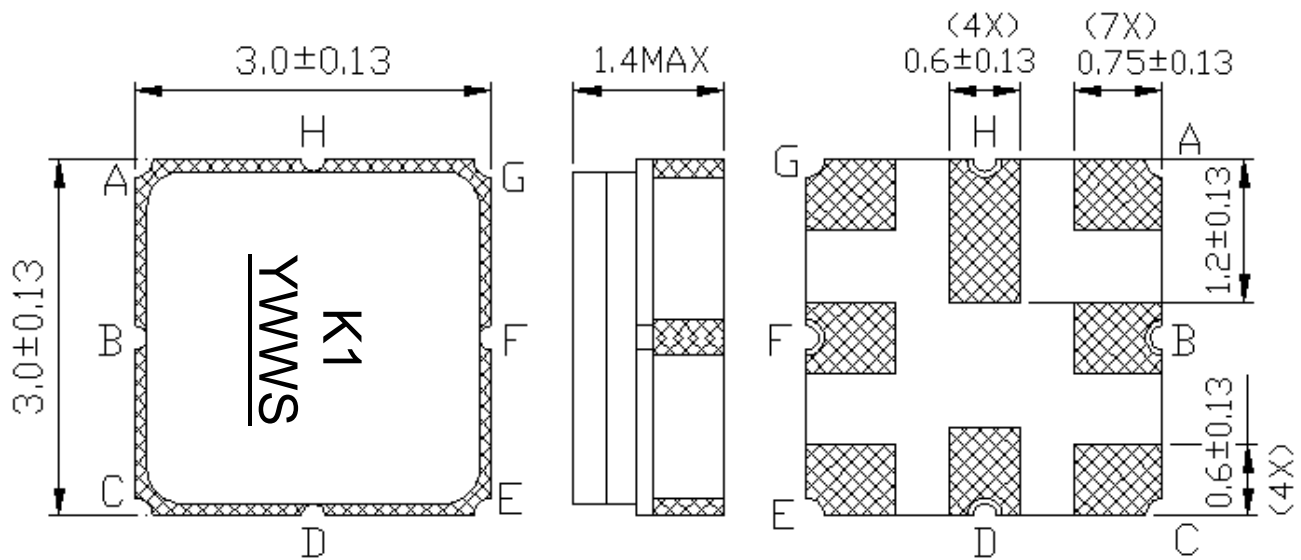
**MEASUREMENT CIRCUIT:**

**50 Ohm Test circuit (single-ended / single-ended)**



**L1=L2=56nH**

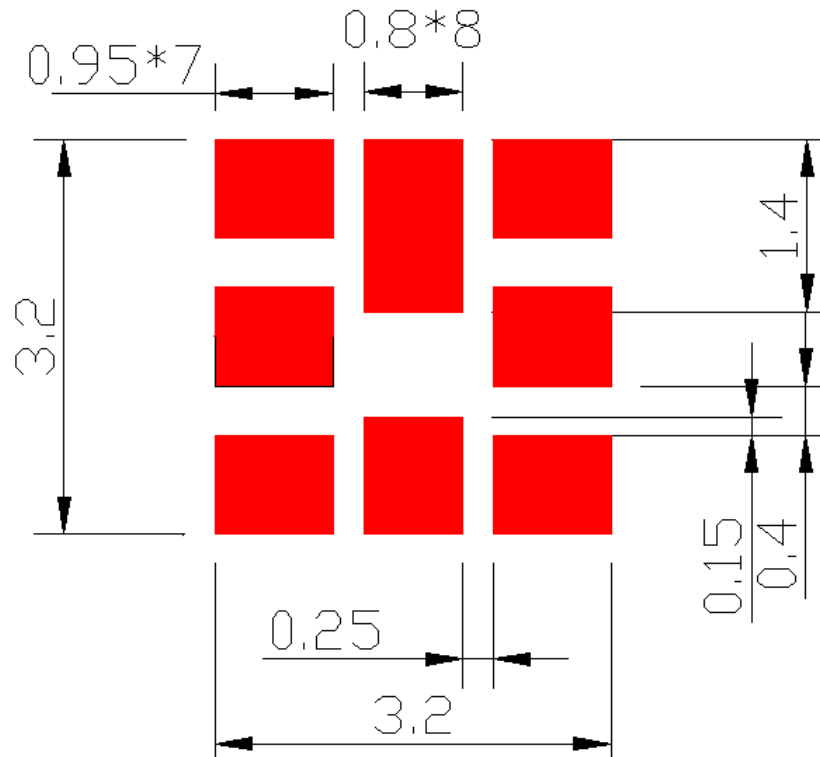
**OUTLINE DRAWING:**



Y = Year, WW = Week, S = Shift

**#A: Input**  
**#E: Output**  
**Others: To be grounded**  
**Unit mm**

PCB FOOTPRINT:





## Recommended Reflow Profile

1. Preheating shall be fixed at 150~180°C for 60~90 seconds.
2. Ascending time to preheating temperature 150°C shall be 30 seconds min.
3. Heating shall be fixed at 220°C for 50~80 seconds and at 260°C +0/-5°C peak (10 seconds).
4. Time: 5 times maximum.

